

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V _{CC}	-50V
I _{C(MAX.)}	-100mA
R ₁	100kΩ
R ₂	100kΩ

Features

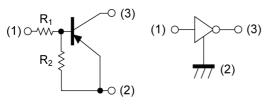
- 1) Built-In Biasing Resistors, $R_1 = R_2 = 100 \text{k}\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC115E series

Application

INVERTER, INTERFACE, DRIVER

•Inner circuit

DTA115EM/ DTA115EEB/ DTA115EUB

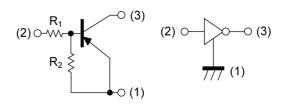


- (1) IN (BASE)
- (2) GND (+) (EMITTER)
- (3) OUT (COLLECTOR)

Outline

- Outilitie	
SOT-723	SOT-416FL
DTA115EM (VMT3)	DTA115EEB (EMT3F)
SOT-723	SOT-323FL
DTA115EE (EMT3)	DTA115EUB (UMT3F)
SOT-323	SOT-346
DTA115EUA (UMT3)	DTA115EKA (SMT3)

DTA115EE/ DTA115EUA/ DTA115EKA



- (1) GND (+) (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA115EM	SOT-723	1212	T2L	180	8	8000	19
DTA115EEB	SOT-416FL	1616	TL	180	8	3000	19
DTA115EE	SOT-723	1616	TL	180	8	3000	19
DTA115EUB	SOT-323FL	2021	TL	180	8	3000	19
DTA115EUA	SOT-323	2021	T106	180	8	3000	19
DTA115EKA	SOT-346	2928	T146	180	8	3000	19

● **Absolute maximum ratings** (T_a = 25°C)

P	arameter	Symbol	Values	Unit
Supply voltage			-50	V
Input voltage		V _{IN}	-40 to 10	V
Output current		Io	-20	mA
Collector current		I _{C(MAX)} *1	-100	mA
	DTA115EM		150	
	DTA115EEB		150	
Davis a dia sin ation	DTA115EE	P _D *2	150	\A/
Power dissipation	DTA115EUB	P _D ²	200	mW
	DTA115EUA		200	
	DTA115EKA		200	
Junction temperature	T _j	150	°C	
Range of storage tempera	ture	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
lanut voltore	$V_{l(off)}$	$V_{CC} = -5V, I_{O} = -100 \mu A$	-	-	-0.5	\/
Input voltage	V _{I(on)}	$V_O = -0.3V$, $I_O = -1mA$	-3.0	-	-	V
Output voltage	V _{O(on)}	$I_O = -5mA$, $I_I = -0.25mA$	1	-100	-300	mV
Input current	l _l	V _I = -5V	1	-	-150	μA
Output current	I _{O(off)}	$V_{CC} = -50V, V_{I} = 0V$	1	-	-500	nA
DC current gain	G _I	$V_{O} = -5V, I_{O} = -5mA$	82	-	-	-
Input resistance	R ₁	-	70	100	130	kΩ
Resistance ratio	R ₂ /R ₁	-	0.8	1.0	1.2	-
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves (T_a =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

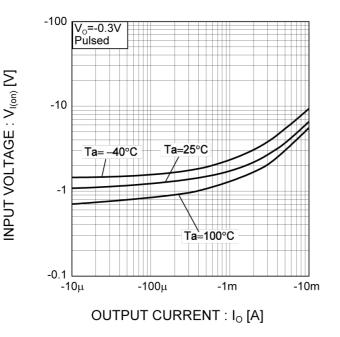


Fig.2 Output current vs. input voltage (OFF characteristics)

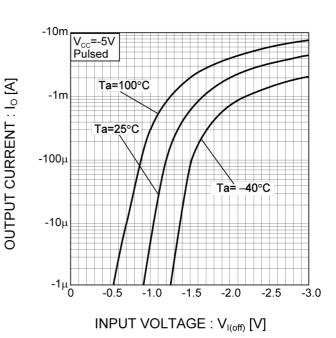


Fig.3 Output current vs. output voltage

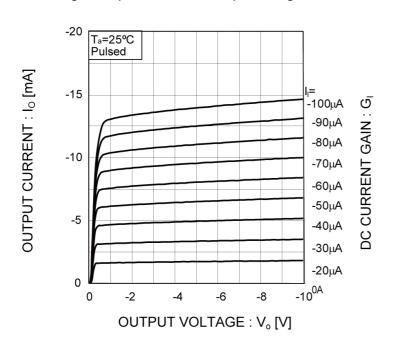
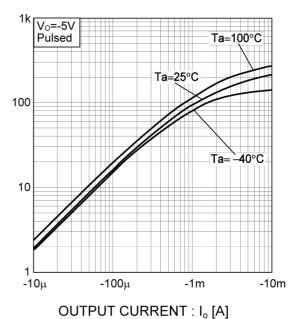
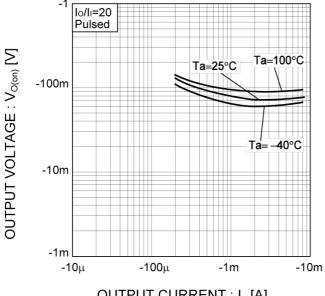


Fig.4 DC current gain vs. output current

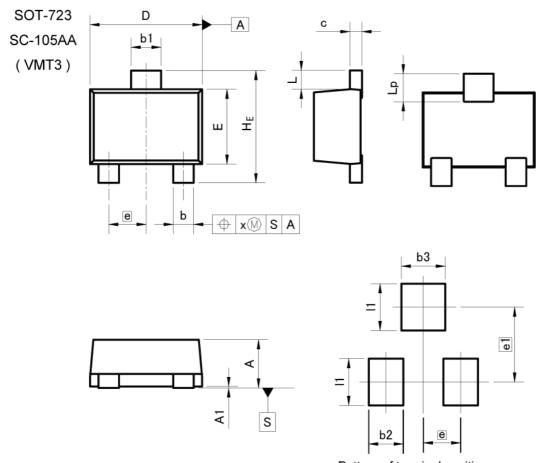


●Electrical characteristic curves (T_a =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT : Io [A]



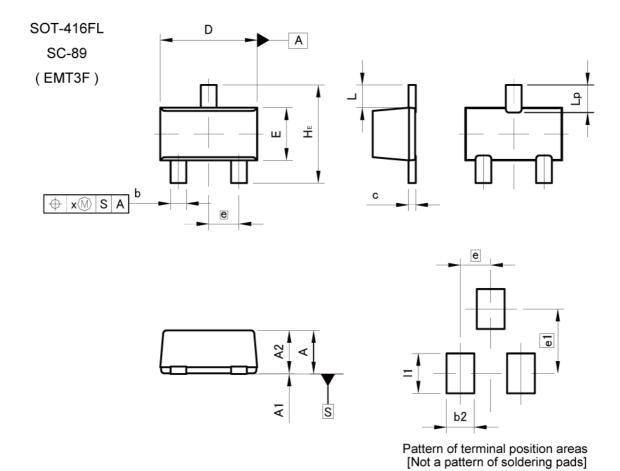
Pattern of terminal position	areas
[Not a pattern of soldering	pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
b1	0.27	0.37	0.011	0.015	
С	0.08	0.18	0.003	0.007	
D	1.10	1.30	0.043	0.051	
E	0.70	0.90	0.028	0.035	
е	0.4	40	0.02		
HE	1.10	1.30	0.043	0.051	
L	0.10	0.30	0.004	0.012	
Lp	0.20	0.40	0.008	0.016	
х	_	0.10	_	0.004	

DIM	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.37	_	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	=	0.50		0.020

Dimension in mm/inches



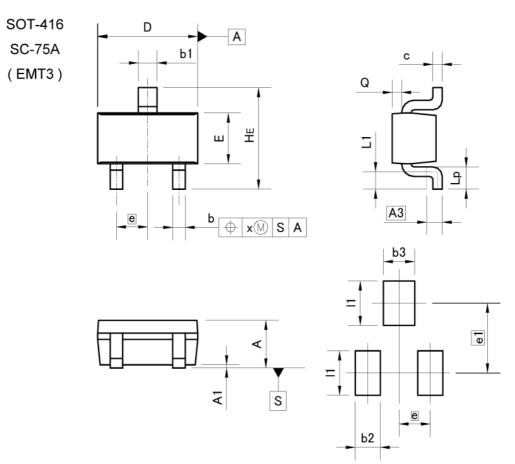


DIM	MILIM	MILIMETERS INC		HES
DIM	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
Х	-	0.10	-	0.004

DIM	MILIMETERS		INCHES			
DIM	MIN	MAX	MIN	MAX		
b2	-	0.46	_	0.018		
e1	-	1.05	_	0.041		
- 11	-	0.65	-	0.026		

Dimension in mm/inches





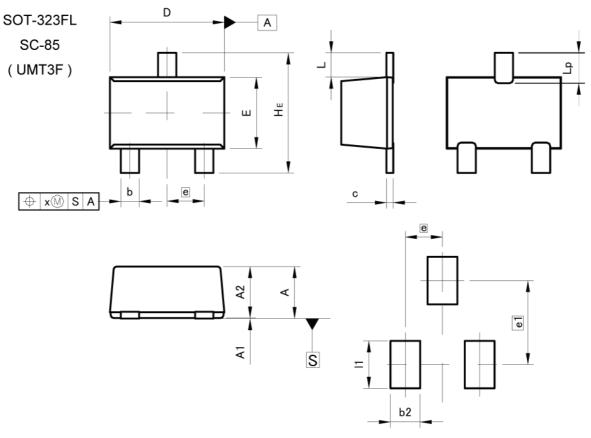
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15		0.006	2=
Q	0.05	0.25	0.002	0.010
х	1. -	0.10	, - ,	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	I	0.50	-	0.020
e1	1.10		0.0	143
l1	i -	0.70	-	0.028

Dimension in mm/inches





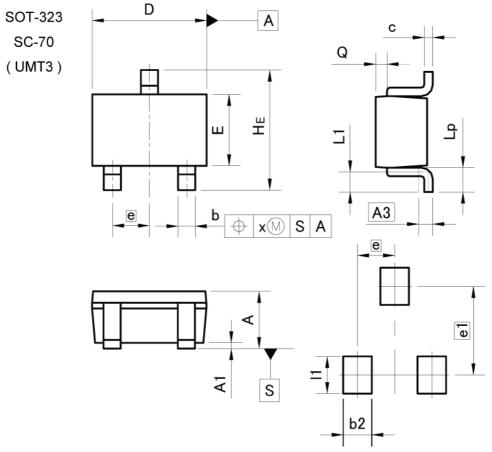
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX	
Α	0.85	1.05	0.033	0.041	
A1	0.00	0.10	0.000	0.004	
A2	0.80	1.00	0.031	0.039	
b	0.27	0.42	0.011	0.017	
С	0.08	0.18	0.003	0.007	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.65		0.026		
HE	2.00	2.20	0.079	0.087	
L	0.425		0.017		
Lp	0.43	0.63	0.017	0.025	
х	_	0.10	-	0.004	

	DIM	MILIMETERS		INCHES	
		MIN	MAX	MIN	MAX
	b2	_	0.52	-	0.020
	e1	1.47		0.058	
	I1	ı	0.83	ı	0.033

Dimension in mm/inches





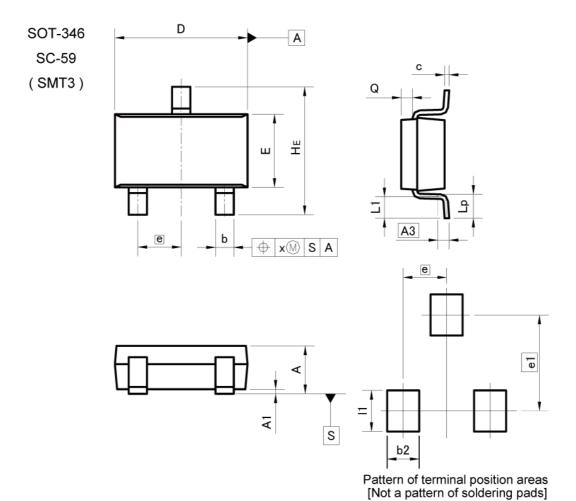
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS INCHES		HES
	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
X	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	_	0.50	_	0.020
e1	1.55		0.061	
- 11	-	0.65	-	0.026

Dimension in mm/inches





DIM	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lр	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	_	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-,	0.60	-	0.024
e1	2.10		0.083	
- 11		0.90	-	0.035

0.10

Dimension in mm/inches



0.004

Notice

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JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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